

Specification of Thermoelectric Module

TES1-12725

Description

The 127 couples, 30mm x 30mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

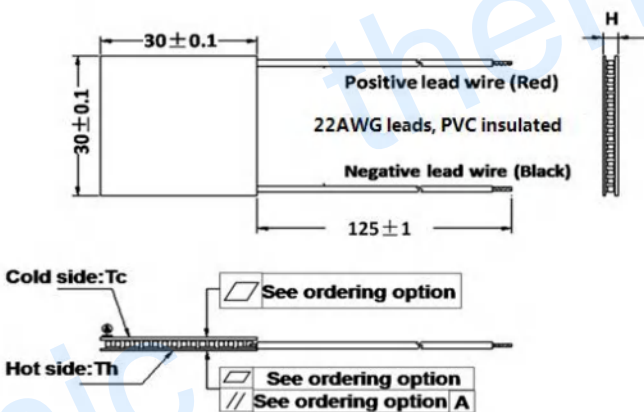
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

| | | | |
|----------------------------|------|------|---|
| Th (°C) | 27 | 50 | Hot side temperature at environment: dry air, N ₂ |
| DT _{max} (°C) | 70 | 79 | Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side |
| U _{max} (Voltage) | 15.9 | 17.2 | Voltage applied to the module at DT _{max} |
| I _{max} (Amps) | 2.51 | 2.51 | DC current through the modules at DT _{max} |
| Q _{Cmax} (Watts) | 25.3 | 27.2 | Cooling capacity at cold side of the module under DT=0 °C |
| AC resistance (Ohms) | 4.8 | 5.2 | The module resistance is tested under AC |
| Tolerance (%) | 10% | | For thermal and electricity parameters |

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:

1. T100: BiSn (T_{melt}=138°C)
2. T200: CuAgSn (T_{melt} = 217°C)
3. T240: SbSn (T_{melt} = 240°C)

B. Sealant:

1. NS: No sealing (Standard)
2. SS: Silicone sealant
3. EPS: Epoxy sealant

C. Ceramics:

1. Alumina (Al₂O₃, white 96%)
2. Aluminum Nitride (AlN)

D. Ceramics Surface Options:

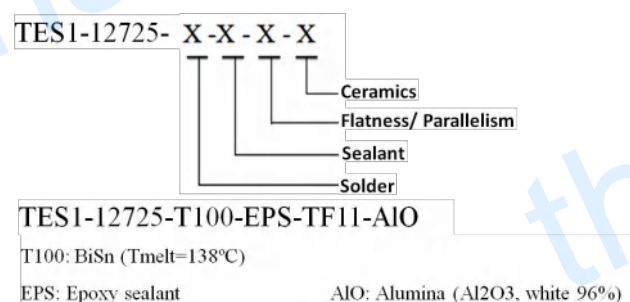
1. Blank ceramics (not metalized)
2. Metalized

Ordering Option

| Suffix | Thickness H (mm) | Flatness/ Parallelism (mm) | Lead wire length(mm) Standard/Optional length |
|--------|------------------|----------------------------|---|
| TF | 0: 4.0± 0.1 | 0: 0.07/0.07 | 125±1/Specify |
| TF | 1: 4.0 ± 0.03 | 1: 0.025/0.025 | 125±1/Specify |

Eg. TF11: Thickness 4.0± 0.03(mm) and Flatness 0.025/0.025 (mm)

Naming for the Module



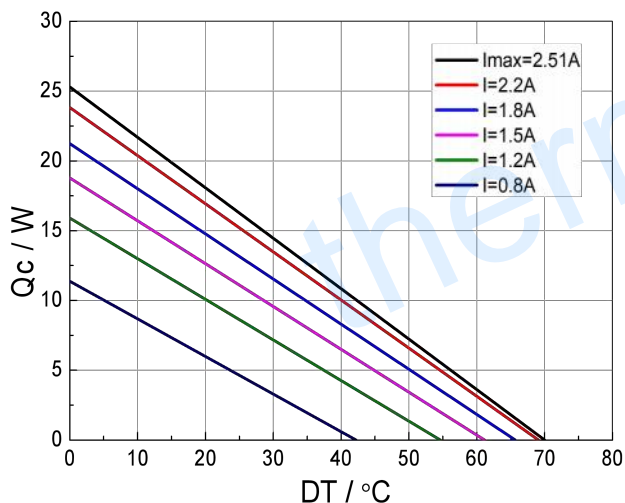
Creative technology with fine manufacturing processes provides you the reliable and quality products

Tel: +86-791-88198288 Fax: +86-791-88198308 Email: sales@thermonamic.com.cn Web Site: www.thermonamic.com.cn

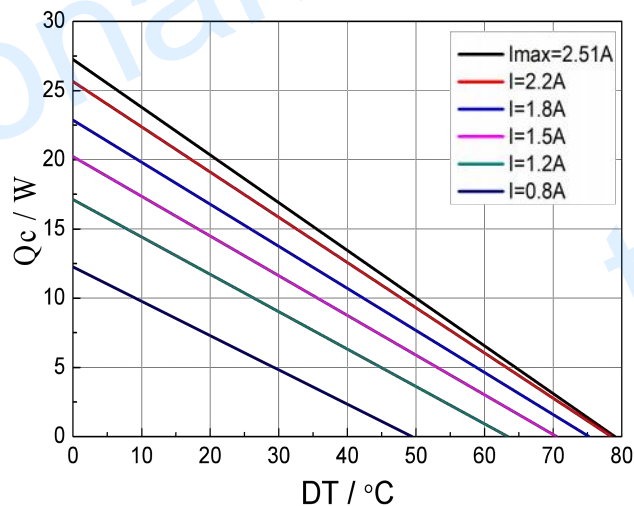
Specification of Thermoelectric Module

TES1-12725

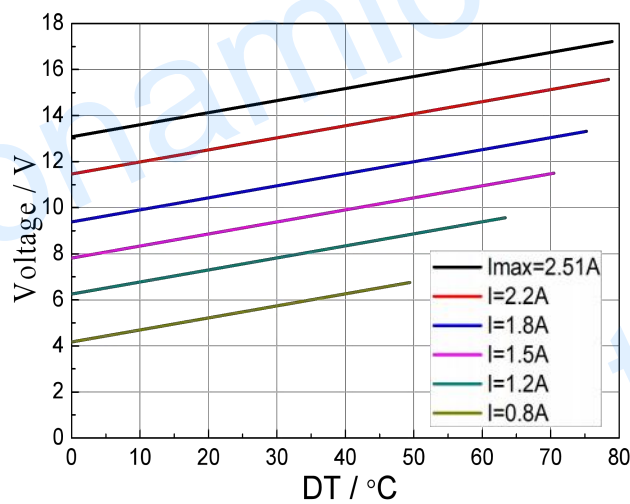
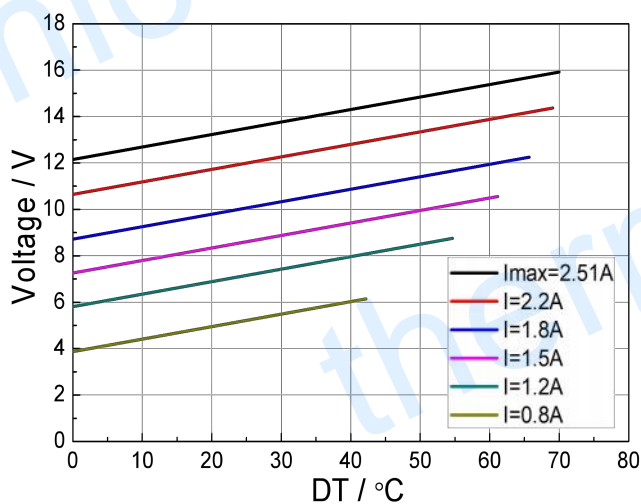
Performance Curves at $T_h=27^\circ\text{C}$



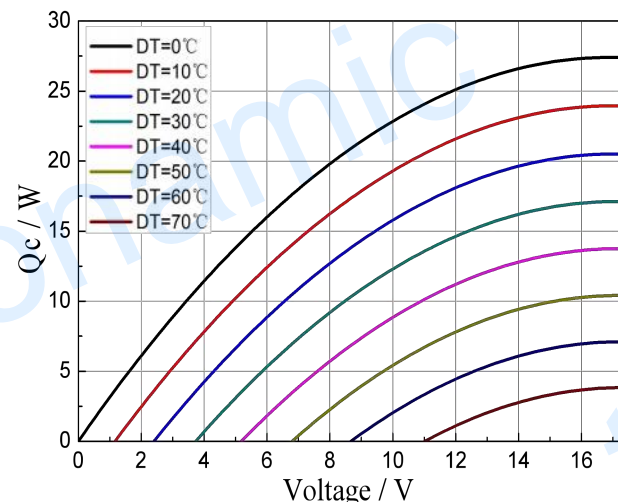
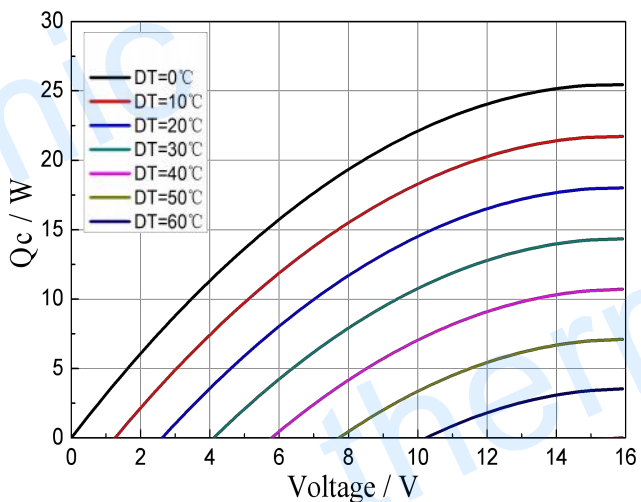
Performance Curves at $T_h=50^\circ\text{C}$



Standard Performance Graph $Q_c = f(DT)$



Standard Performance Graph $V = f(DT)$

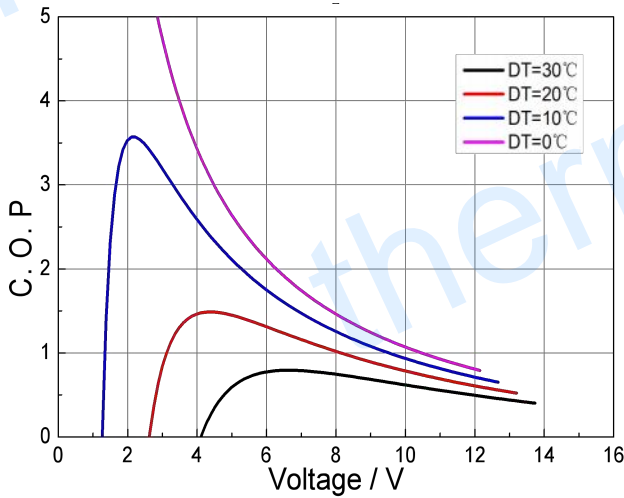


Standard Performance Graph $Q_c = f(V)$

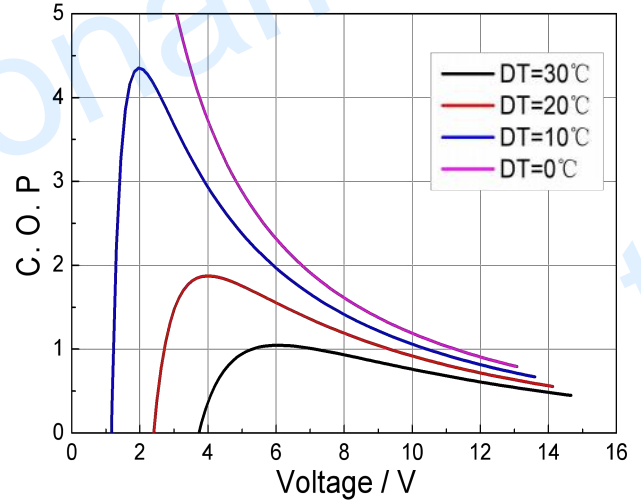
Specification of Thermoelectric Module

TES1-12725

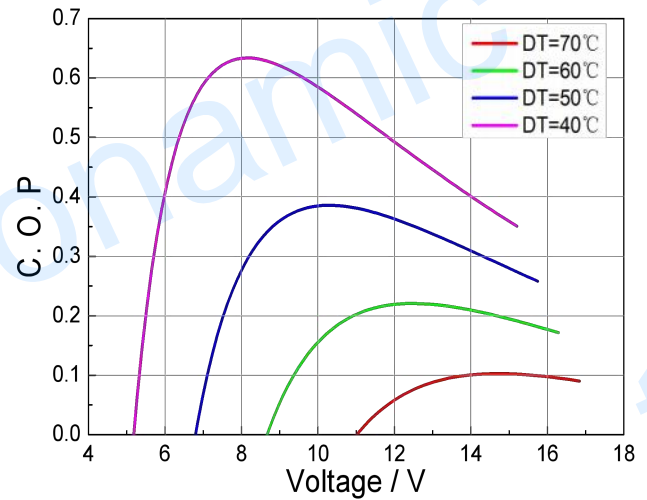
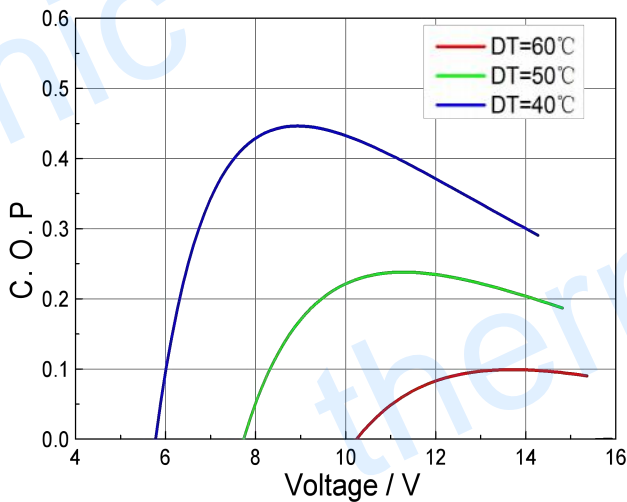
Performance Curves at $T_h = 27^\circ\text{C}$



Performance Curves at $T_h = 50^\circ\text{C}$



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Q_c /Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.